

S/N 09/259849

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Paul A. Farrar

Examiner: Ginette Peralta

Serial No.: 09/259849

Group Art Unit: 2814

Filed: March 1, 1999

Docket: 303.557US1

Title: CONDUCTIVE STRUCTURES IN INTEGRATED CIRCUITS



COMMUNICATION CONCERNING RELATED APPLICATION(S)

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the above-identified patent application:

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<u>Serial/Patent No.</u>	<u>Filing Date</u>	<u>Attorney Docket</u>	<u>Title</u>
09/032197 6211073	February 27, 1998	303.459US1	METHODS FOR MAKING COPPER AND OTHER METAL INTERCONNECTIONS IN INTEGRATED CIRCUITS
09/817447	March 26, 2001	303.459US2	METHODS FOR MAKING COPPER AND OTHER METAL INTERCONNECTIONS IN INTEGRATED CIRCUITS
09/128859 6284656	August 4, 1998	303.473US1	COPPER METALLURGY IN INTEGRATED CIRCUITS
09/946055 6614099	September 4, 2001	303.473US2	COPPER METALLURGY IN INTEGRATED CIRCUITS
09/145012 6288442	September 1, 1998	303.505US1	INTEGRATED-CIRCUIT WITH OXIDATION-RESISTANT POLYMERIC LAYER
09/256123 6211049	February 24, 1999	303.505US2	FORMING SUBMICRON INTEGRATED-CIRCUIT WIRING FROM GOLD, SILVER, COPPER AND OTHER METALS

COMMUNICATION CONCERNING CO-PENDING APPLICATIONS

Serial Number: 09/259849

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09/256124 6208016	February 24, 1999	303.505US3	FORMING SUBMICRON INTEGRATED-CIRCUIT WIRING FROM GOLD, SILVER, COPPER AND OTHER METALS
09/789091	February 20, 2001	303.505US4	INTEGRATED-CIRCUIT WITH OXIDATION-RESISTANT POLYMERIC LAYER

Respectfully submitted,

PAUL A. FARRAR

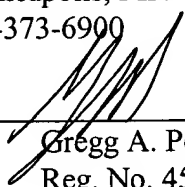
By Applicant's Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
P.O. Box 2938  
Minneapolis, MN 55402  
612-373-6900

Date

11-14-03

By



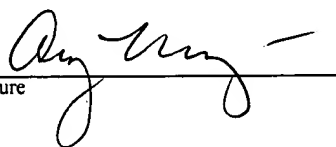
Gregg A. Peacock  
Reg. No. 45,001

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Name

Amy Moriarty

Signature



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Applicant: Paul A. Farrar

Title: CONDUCTIVE STRUCTURES IN INTEGRATED CIRCUITS

Docket No.: 303.557US1

Filed: March 1, 1999

Examiner: Ginette Peralta

Customer No.: 21186



Serial No.: 09/259849

Due Date: November 14, 2003

Group Art Unit: 2814

Confirmation No.: 5766

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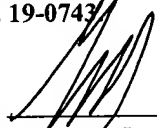
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We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
- ☒ An Amendment and Response (20 Pages).
- ☒ Communication Concerning Co-Pending Applications (2 pgs.).

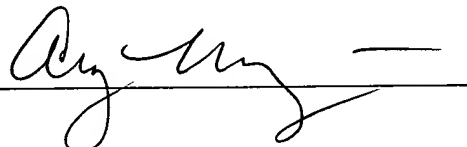
Please consider this a **PETITION FOR EXTENSION OF TIME** for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
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By:   
Atty: Gregg A. Peacock  
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Amy Moriarty  
Name

  
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SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.  
(GENERAL)

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